Product Summary (Typ @V_{GS} = -4.5V, T_A = +25°C)

BV_{DSS}	$R_{DS(ON)}$	Q_g	Q_{gd}	I_D
-12V	65mΩ	9nC	2.4nC	-3.2A

Features and Benefits

- Built-in G-S Protection Diode against ESD 2kV HBM
- Ultra Small 0.8mm x 0.8mm Package
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Description and Applications

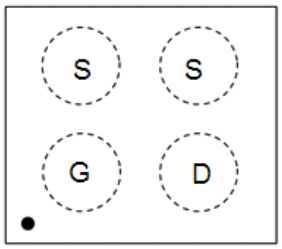
This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications. It is a high-performance MOSFET in ultra-small 0.8mm x 0.8mm package.

- Portable Applications
- Load Switch
- Power Management Functions

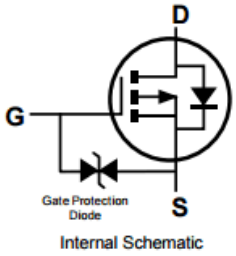
Mechanical Data

- Case: X2-WLB0808-4
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- UBM Opening: 203µm





Top View



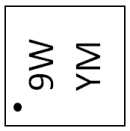
Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMP1100UCB4-7	X2-WLB0808-4	3,000/Tape & Reel

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



9W = Product Type Marking Code
YM = Date Code Marking
Y or $\overline{Y}$ = Year (ex: D = 2016)
M or $\overline{M}$ = Month (ex: 9 = September)

Date Code Key

Year	2016	2017	2018	2019	2020	2021	2022
Code	D	E	F	G	H	I	J

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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Maximum Ratings

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	-12	V
Gate-Source Voltage		V_{GSS}	±8	V
Continuous Source Current @ V_{GS} = -4.5V (Note 5)	T_A = +25°C T_A = +70°C	I_D	-2.5 -2.0	A
Continuous Source Current @ V_{GS} = -4.5V (Note 6)	T_A = +25°C T_A = +70°C	I_D	-3.2 -2.6	A
Pulsed Drain Current (Pulse Duration 10µs, Duty Cycle ≤1%)		I_{DM}	-13	A
Continuous Source-Drain Diode Current		I_S	-1.2	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P_D	0.67	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	187	°C/W
Total Power Dissipation (Note 6)	P_D	1.1	W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	117	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV_{DSS}	-12	-	-	V	V_{GS} = 0V, I_D = -250µA
Zero Gate Voltage Drain Current	I_{DSS}	-	-	–1	µA	V_{DS} = -12V, V_{GS} = 0V
Gate-Body Leakage	I_{GSS}	-	-	±10	µA	V_{GS} = ±8V, V_{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(TH)}$	-0.35	-0.55	-0.8	V	V_{DS} = V_{GS}, ID = -250µA
Static Drain-Source On-Resistance	$R_{DS(ON)}$	-	65 80 90 115 135 150	83 96 150 170 300 400	mΩ	V_{GS} = -4.5V, I_D = -3A V_{GS} = -2.5V, I_D = -2A V_{GS} = -1.8V, I_D = -1A V_{GS} = -1.5V, I_D = -1A V_{GS} = -1.4V, I_D = -1A V_{GS} = -1.3V, I_D = -1A
Forward Transfer Admittance	$\|Y_{fs}\|$	-	6.5	-	S	V_{DS} = -4V, I_S = -1.5A
Body Diode Forward Voltage	V_{SD}	-	-0.7	-	V	V_{GS} = 0V, I_S = -1.5A,
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C_{iss}	-	680	820	pF	V_{DS} = -6V, V_{GS} = 0V, f = 1.0MHz
Output Capacitance	C_{oss}	-	220	290	pF	
Reverse Transfer Capacitance	C_{rss}	-	205	280	pF	
Gate Resistance	R_g	-	11.2	17	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz
Total Gate Charge	Q_g	-	9.0	14	nC	V_{GS} = -4.5V, V_{DS} = -6V, I_D = -2A
Gate-Source Charge	Q_{gs}	-	1.0	-	nC	
Gate-Drain Charge	Q_{gd}	-	2.6	-	nC	
Turn-On Delay Time	$t_{D(ON)}$	-	4.4	9	ns	V_{DD} = -4V, I_D = -2A V_{GEN} = -4.5V, R_g = 1Ω, R_L = 3Ω
Turn-On Rise Time	t_R	-	10.1	-	ns	
Turn-Off Delay Time	$t_{D(OFF)}$	-	22	33	ns	
Turn-Off Fall Time	t_F	-	20	-	ns	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
7. Short duration pulse test used to minimize self-heating effect.

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Electrical Characteristics (@T_A = 0°C.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
ON CHARACTERISTICS (Note 7,Note 8)						
Static Drain-Source On-Resistance	$R_{DS(ON)}$	-	62 78 88 112 130 150	83 96 150 170 300 400	mΩ	V_{GS} = -4.5V, I_D = -3A V_{GS} = -2.5V, I_D = -2A V_{GS} = -1.8V, I_D = -1A V_{GS} = -1.5V, I_D = -1A V_{GS} = -1.4V, I_D = -1A V_{GS} = -1.3V, I_D = -1A

Electrical Characteristics (@T_A = + 65°C.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
ON CHARACTERISTICS (Note 7,Note 8)						
Static Drain-Source On-Resistance	$R_{DS(ON)}$	-	73 89 107 127 141 163	93 118 185 195 300 400	mΩ	V_{GS} = -4.5V, I_D = -3A V_{GS} = -2.5V, I_D = -2A V_{GS} = -1.8V, I_D = -1A V_{GS} = -1.5V, I_D = -1A V_{GS} = -1.4V, I_D = -1A V_{GS} = -1.3V, I_D = -1A

Note: 8. Guaranteed by design. Not subject to production testing.

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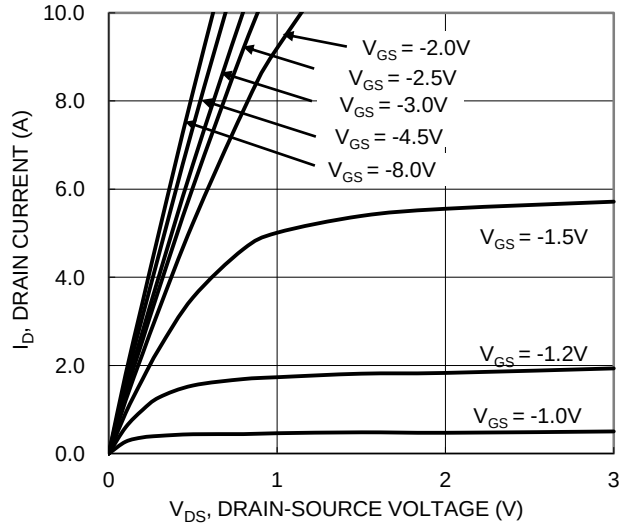


Figure 1. Typical Output Characteristic

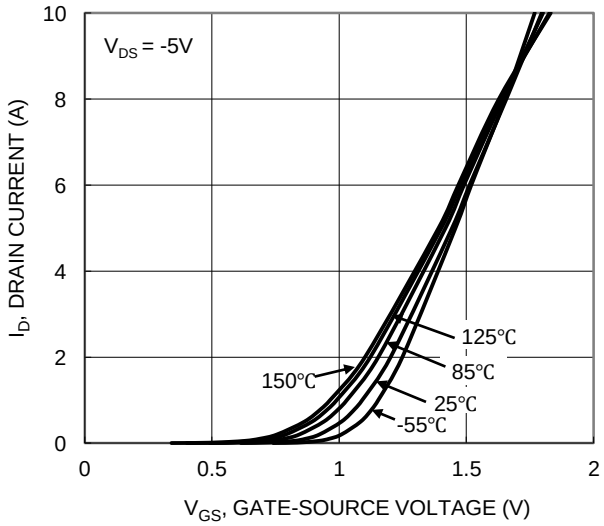


Figure 2. Typical Transfer Characteristic

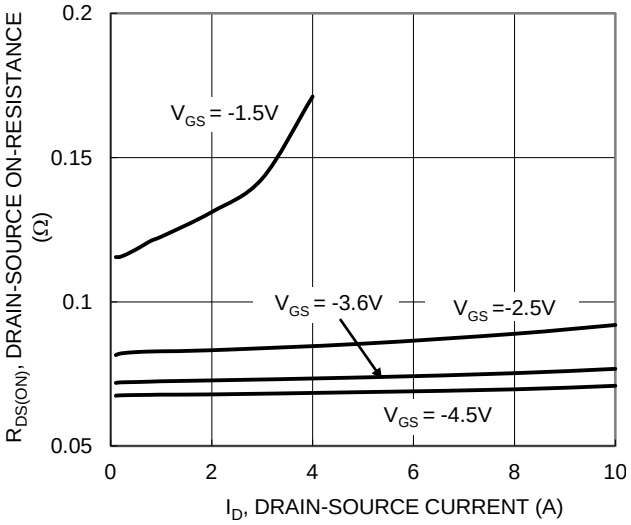


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

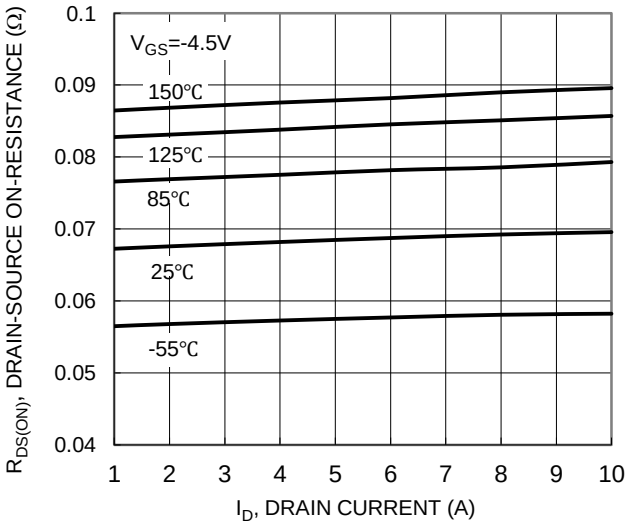


Figure 4. Typical On-Resistance vs. Drain Current and Junction Temperature

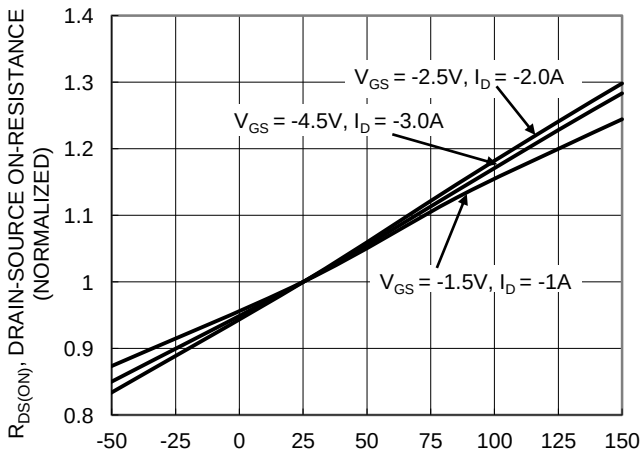


Figure 5. On-Resistance Variation with Junction Temperature

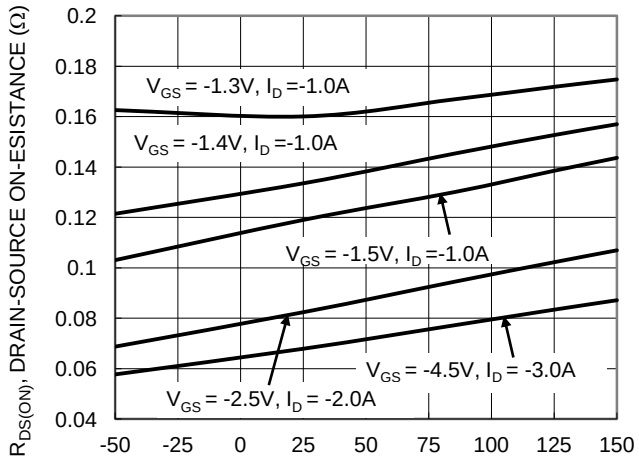


Figure 6. On-Resistance Variation with Junction Temperature

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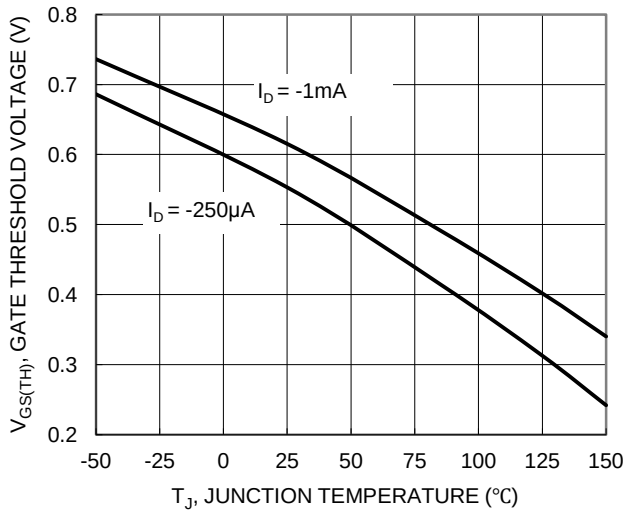


Figure 7. Gate Threshold Variation vs. Junction Temperature

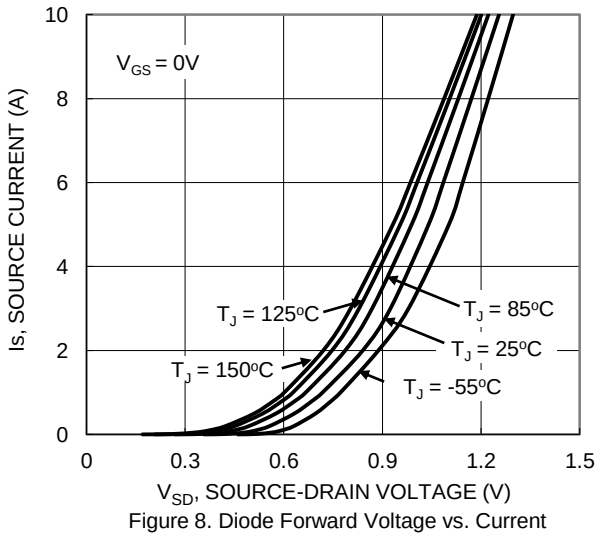


Figure 8. Diode Forward Voltage vs. Current

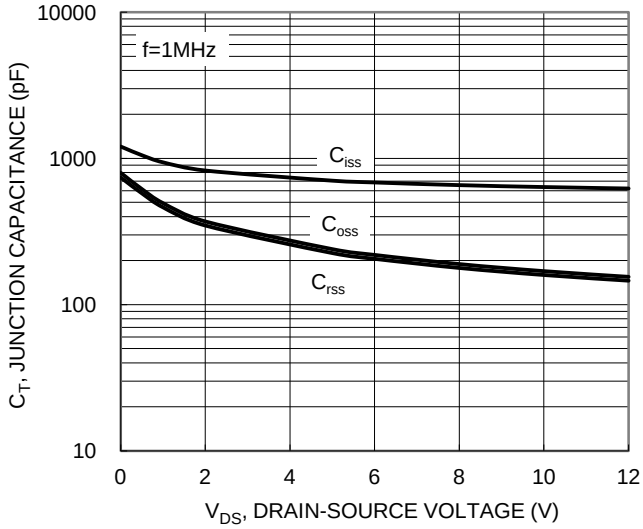


Figure 9. Typical Junction Capacitance

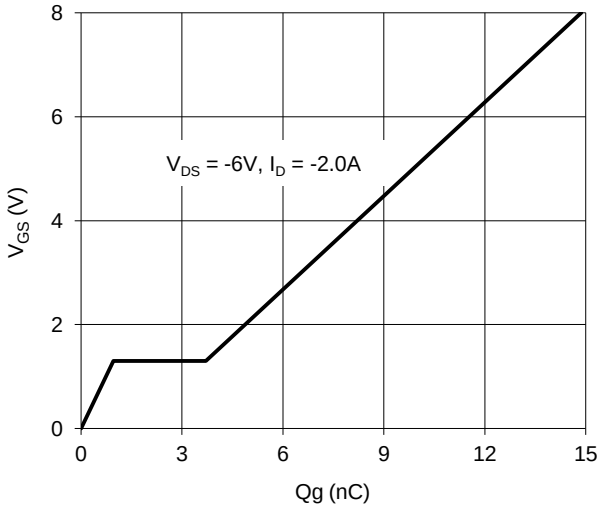


Figure 10. Gate Charge

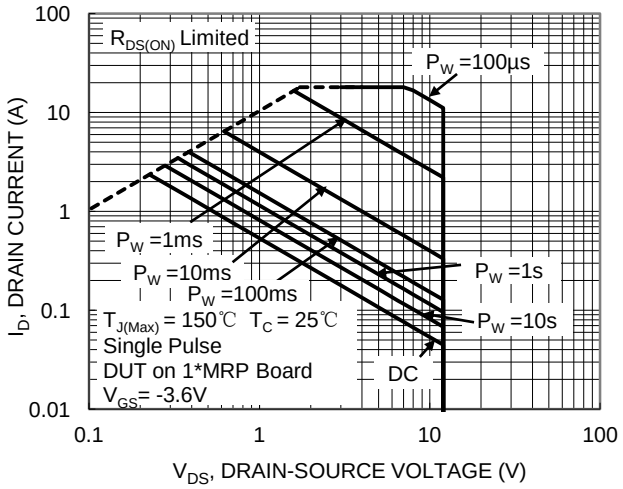


Figure 11. SOA, Safe Operation Area

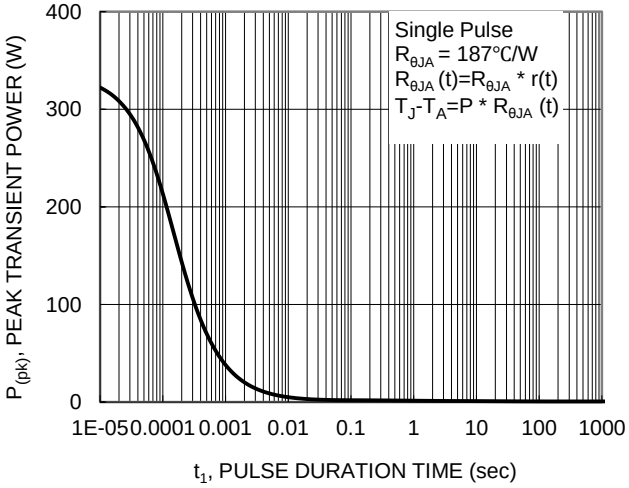


Figure 12. Single Pulse Maximum Power Dissipation

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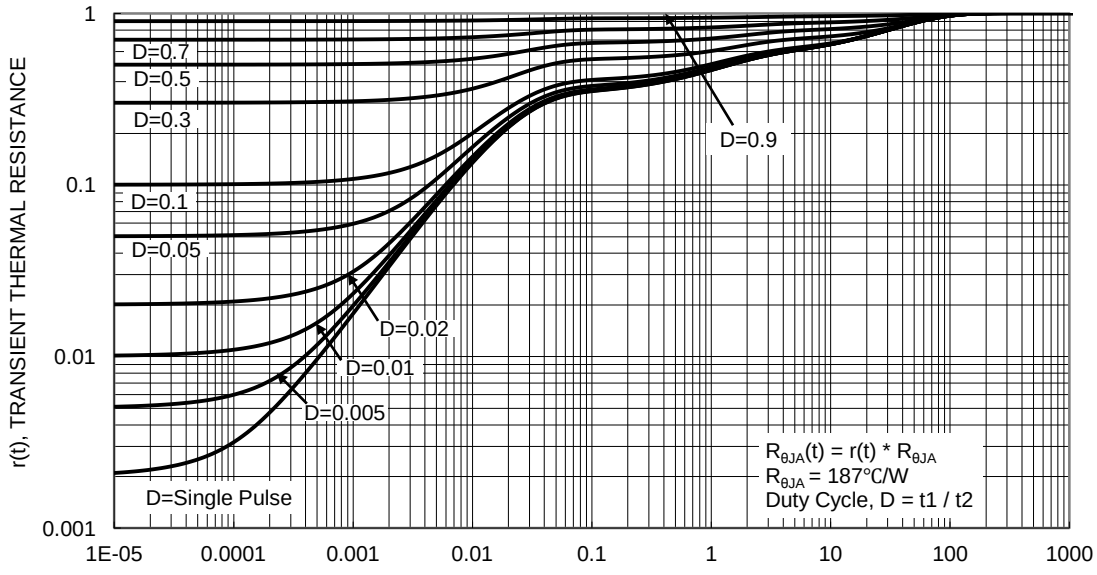


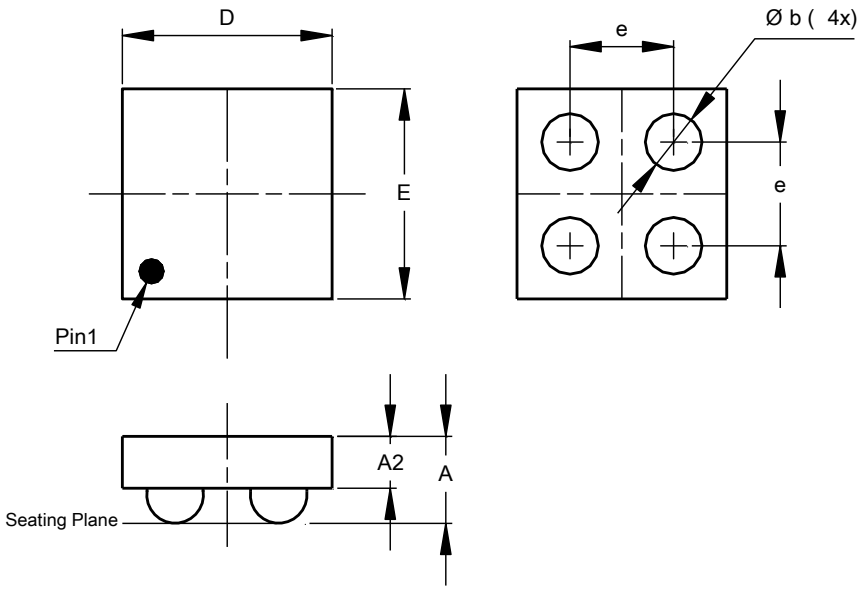
Figure 13. Transient Thermal Resistance

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Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-WLB0808-4

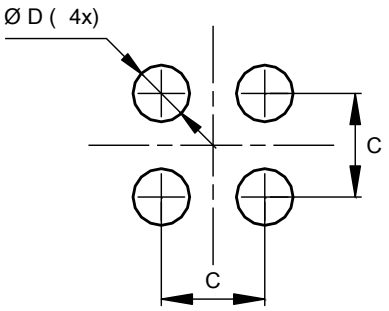


X2-WLB0808-4			
Dim	**Min**	**Max**	**Typ**
A	--	0.400	0.375
A2	--	--	0.180
b	0.1971	0.2409	0.219
D	0.790	0.820	0.816
E	0.790	0.820	0.816
e	--	--	0.400
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-WLB0808-4



Dimensions	Value (in mm)
C	0.400
D	0.219

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